



## Description

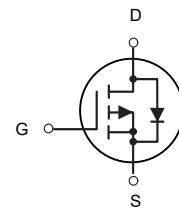
The AOD409 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



## General Features

$V_{DS} = -60V$   $I_D = -50A$

$R_{DS(ON)} < 24\text{ m}\Omega$  @  $V_{GS}=10V$



P-Channel MOSFET

## Application

Battery protection

Load switch

Uninterruptible power supply

## Package Marking and Ordering Information

| Product ID | Pack                          | Marking          | Qty(PCS) |
|------------|-------------------------------|------------------|----------|
| AOD409     | TO-252-2L<br>(TO-252-2(DPAK)) | HXY/OD409/xxxxxx | 2500     |

## Absolute Maximum Ratings ( $T_C=25^{\circ}\text{C}$ unless otherwise noted)

| Symbol                        | Parameter                                             | Rating     | Units                |
|-------------------------------|-------------------------------------------------------|------------|----------------------|
| $V_{DS}$                      | Drain-Source Voltage                                  | -60        | V                    |
| $V_{GS}$                      | Gate-Source Voltage                                   | $\pm 20$   | V                    |
| $I_D@T_C=25^{\circ}\text{C}$  | Continuous Drain Current, $V_{GS}$ @ 10V <sup>1</sup> | -50        | A                    |
| $I_D@T_C=100^{\circ}\text{C}$ | Continuous Drain Current, $V_{GS}$ @ 10V <sup>1</sup> | -27        | A                    |
| $I_{DM}$                      | Pulsed Drain Current <sup>2</sup>                     | -70        | A                    |
| $P_D@T_C=25^{\circ}\text{C}$  | Total Power Dissipation <sup>4</sup>                  | 52.1       | W                    |
| TSTG                          | Storage Temperature Range                             | -55 to 150 | $^{\circ}\text{C}$   |
| $T_J$                         | Operating Junction Temperature Range                  | -55 to 150 | $^{\circ}\text{C}$   |
| $R_{\theta JA}$               | Thermal Resistance Junction-ambient <sup>1</sup>      | 62         | $^{\circ}\text{C/W}$ |
| $R_{\theta JC}$               | Thermal Resistance Junction-Case <sup>1</sup>         | 2.4        | $^{\circ}\text{C/W}$ |



## Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

| Symbol                       | Parameter                                      | Conditions                                                     | Min. | Typ.   | Max.      | Unit                |
|------------------------------|------------------------------------------------|----------------------------------------------------------------|------|--------|-----------|---------------------|
| $BV_{DSS}$                   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V$ , $I_D=-250\mu A$                                  | -60  | ---    | ---       | V                   |
| $\Delta BV_{DSS}/\Delta T_J$ | $BV_{DSS}$ Temperature Coefficient             | Reference to $25^\circ\text{C}$ , $I_D=-1\text{mA}$            | ---  | -0.035 | ---       | $V/^\circ\text{C}$  |
| $R_{DS(ON)}$                 | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=-10V$ , $I_D=-18A$                                     | ---  | 20     | 24        | $m\Omega$           |
|                              |                                                | $V_{GS}=-4.5V$ , $I_D=-12A$                                    | ---  | 25     | 30        |                     |
| $V_{GS(th)}$                 | Gate Threshold Voltage                         | $V_{GS}=V_{DS}$ , $I_D=-250\mu A$                              | -1.0 | ---    | -2.5      | V                   |
| $\Delta V_{GS(th)}$          | $V_{GS(th)}$ Temperature Coefficient           |                                                                | ---  | 4.28   | ---       | $mV/^\circ\text{C}$ |
| $I_{DSS}$                    | Drain-Source Leakage Current                   | $V_{DS}=-48V$ , $V_{GS}=0V$ , $T_J=25^\circ\text{C}$           | ---  | ---    | 1         | $\mu A$             |
|                              |                                                | $V_{DS}=-48V$ , $V_{GS}=0V$ , $T_J=55^\circ\text{C}$           | ---  | ---    | 5         |                     |
| $I_{GSS}$                    | Gate-Source Leakage Current                    | $V_{GS}=\pm 20V$ , $V_{DS}=0V$                                 | ---  | ---    | $\pm 100$ | nA                  |
| $g_{fs}$                     | Forward Transconductance                       | $V_{DS}=-10V$ , $I_D=-18A$                                     | ---  | 23     | ---       | S                   |
| $R_g$                        | Gate Resistance                                | $V_{DS}=0V$ , $V_{GS}=0V$ , $f=1\text{MHz}$                    | ---  | 7      | ---       | $\Omega$            |
| $Q_g$                        | Total Gate Charge (-4.5V)                      | $V_{DS}=-20V$ , $V_{GS}=-4.5V$ , $I_D=-12A$                    | ---  | 25     | ---       | nC                  |
| $Q_{gs}$                     | Gate-Source Charge                             |                                                                | ---  | 6.7    | ---       |                     |
| $Q_{gd}$                     | Gate-Drain Charge                              |                                                                | ---  | 5.5    | ---       |                     |
| $T_{d(on)}$                  | Turn-On Delay Time                             | $V_{DD}=-15V$ , $V_{GS}=-10V$ , $R_G=3.3\Omega$ ,<br>$I_D=-1A$ | ---  | 38     | ---       | ns                  |
| $T_r$                        | Rise Time                                      |                                                                | ---  | 23.6   | ---       |                     |
| $T_{d(off)}$                 | Turn-Off Delay Time                            |                                                                | ---  | 100    | ---       |                     |
| $T_f$                        | Fall Time                                      |                                                                | ---  | 6.8    | ---       |                     |
| $C_{iss}$                    | Input Capacitance                              | $V_{DS}=-15V$ , $V_{GS}=0V$ , $f=1\text{MHz}$                  | ---  | 3635   | ---       | pF                  |
| $C_{oss}$                    | Output Capacitance                             |                                                                | ---  | 224    | ---       |                     |
| $C_{rss}$                    | Reverse Transfer Capacitance                   |                                                                | ---  | 141    | ---       |                     |

## Diode Characteristics

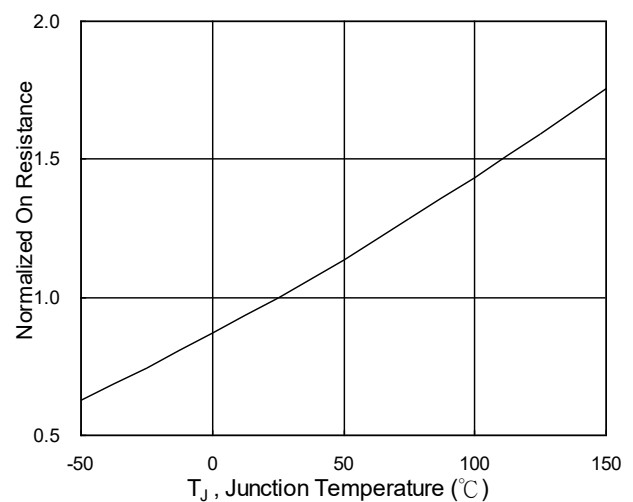
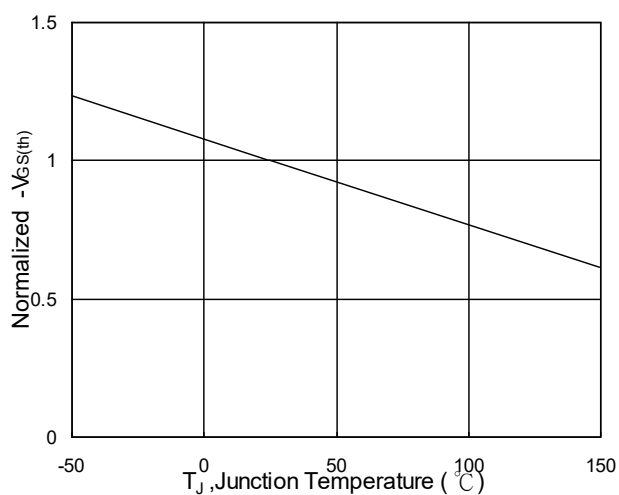
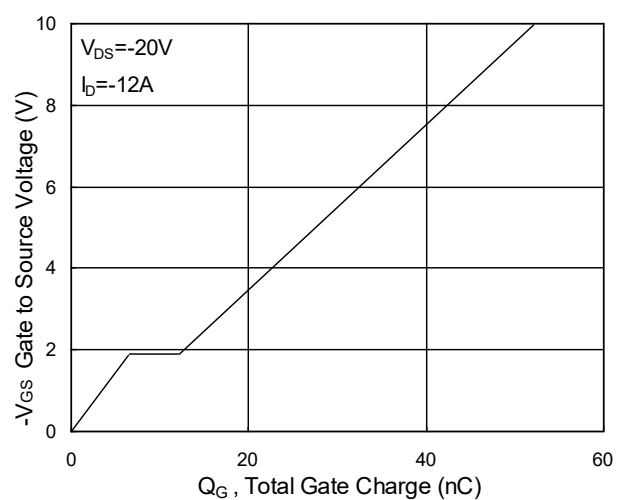
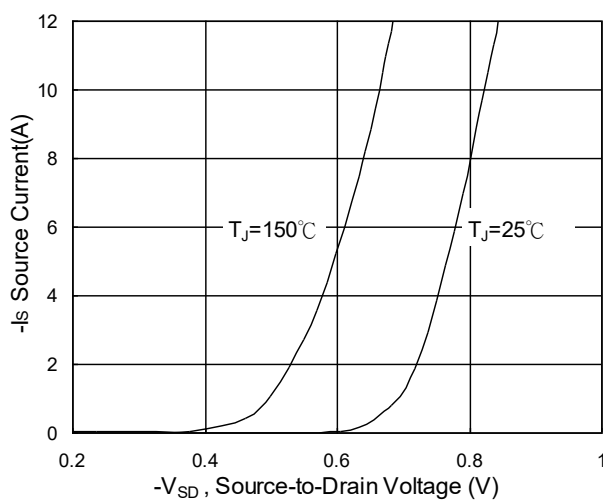
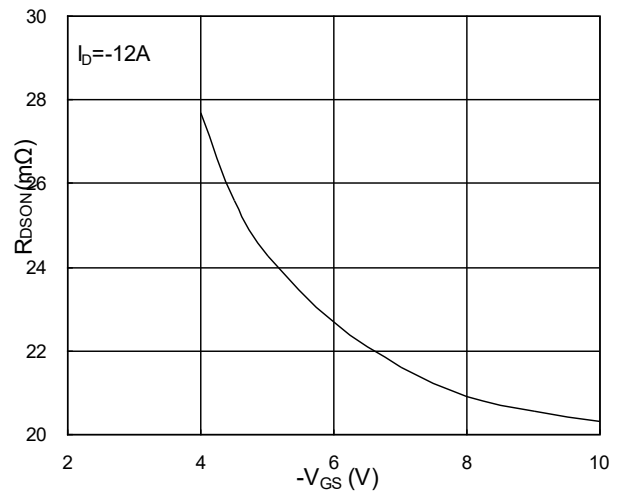
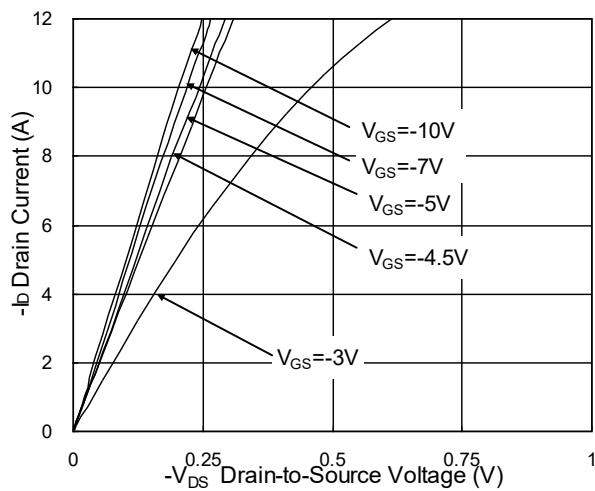
| Symbol   | Parameter                                | Conditions                                       | Min. | Typ. | Max. | Unit |
|----------|------------------------------------------|--------------------------------------------------|------|------|------|------|
| $I_S$    | Continuous Source Current <sup>1,5</sup> | $V_G=V_D=0V$ , Force Current                     | ---  | ---  | -45  | A    |
| $I_{SM}$ | Pulsed Source Current <sup>2,5</sup>     |                                                  | ---  | ---  | -70  | A    |
| $V_{SD}$ | Diode Forward Voltage <sup>2</sup>       | $V_{GS}=0V$ , $I_S=-1A$ , $T_J=25^\circ\text{C}$ | ---  | ---  | -1   | V    |

Note :

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is  $V_{DD}=-25V$ ,  $V_{GS}=-10V$ ,  $L=0.1\text{mH}$ ,  $I_{AS}=-47.6A$
- 4.The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
- 5.The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation.



## Typical Characteristics



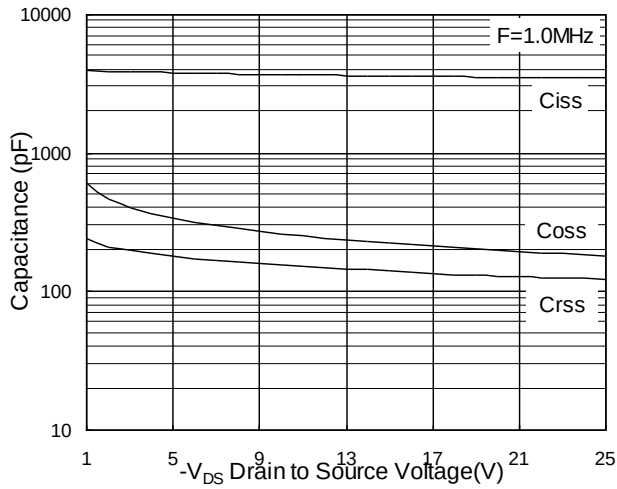


Fig.7 Capacitance

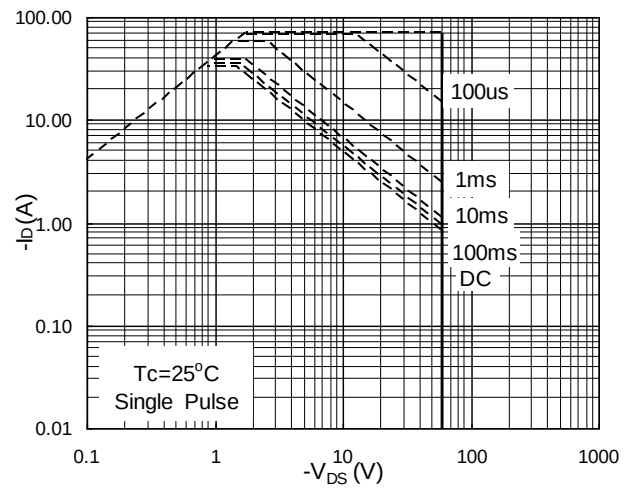


Fig.8 Safe Operating Area

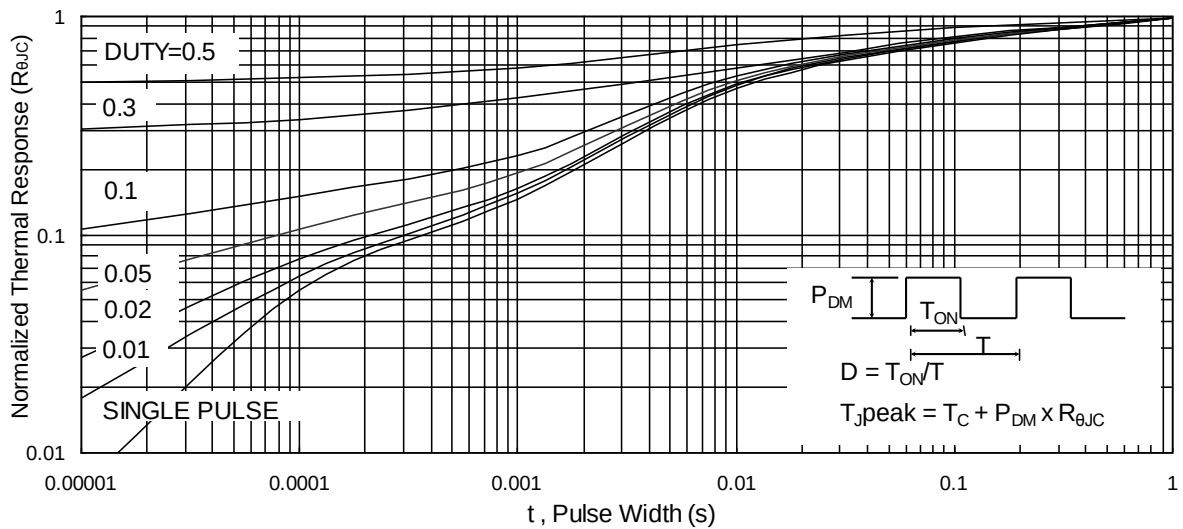


Fig.9 Normalized Maximum Transient Thermal Impedance

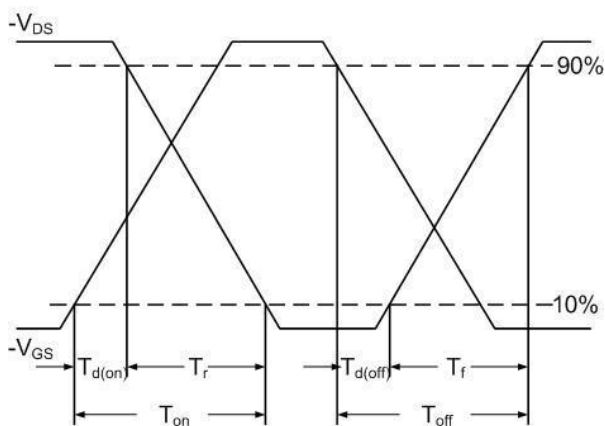


Fig.10 Switching Time Waveform

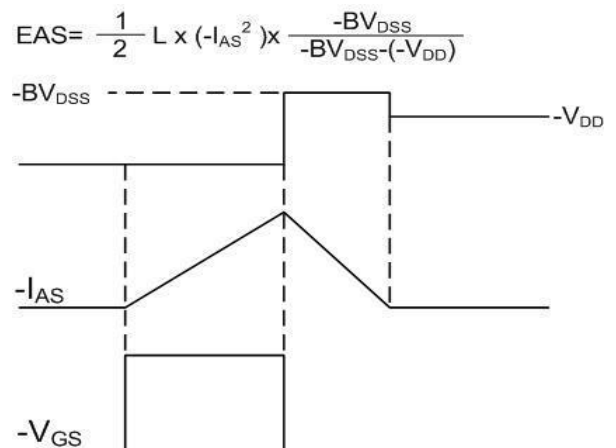
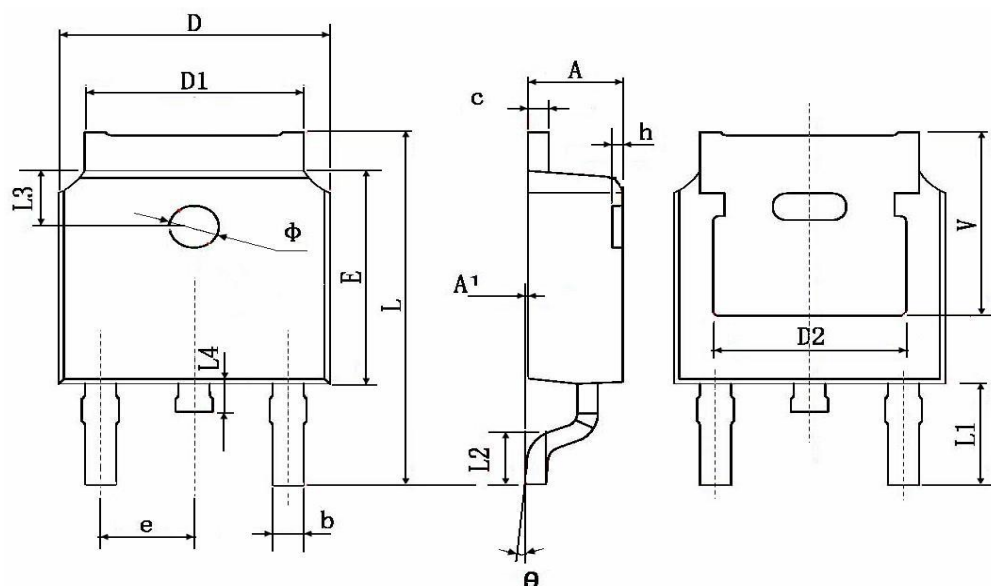


Fig.11 Unclamped Inductive Waveform



## TO-252-2L(TO-252-2(DPAK)) Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 2.200                     | 2.400  | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127  | 0.000                | 0.005 |
| b      | 0.660                     | 0.860  | 0.026                | 0.034 |
| c      | 0.460                     | 0.580  | 0.018                | 0.023 |
| D      | 6.500                     | 6.700  | 0.256                | 0.264 |
| D1     | 5.100                     | 5.460  | 0.201                | 0.215 |
| D2     | 4.830 TYP.                |        | 0.190 TYP.           |       |
| E      | 6.000                     | 6.200  | 0.236                | 0.244 |
| e      | 2.186                     | 2.386  | 0.086                | 0.094 |
| L      | 9.800                     | 10.400 | 0.386                | 0.409 |
| L1     | 2.900 TYP.                |        | 0.114 TYP.           |       |
| L2     | 1.400                     | 1.700  | 0.055                | 0.067 |
| L3     | 1.600 TYP.                |        | 0.063 TYP.           |       |
| L4     | 0.600                     | 1.000  | 0.024                | 0.039 |
| Φ      | 1.100                     | 1.300  | 0.043                | 0.051 |
| θ      | 0°                        | 8°     | 0°                   | 8°    |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |
| V      | 5.350 TYP.                |        | 0.211 TYP.           |       |



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